



**REPUBLIC OF SINGAPORE
THE PATENT ACT (CHAPTER 221)
CERTIFICATE ISSUED UNDER SECTION 35**

I HEREBY CERTIFY that under the provisions of the Patent Act, a patent has been granted in respect of an invention having the following particulars:

TITLE : STRUCTURE FORMED BY TEMPERATURE DIFFERENCE, METHOD OF FORMING THE STRUCTURE, AND LIGHTWEIGHT RIGID ASSEMBLY COMPRISING THE STRUCTURE

**APPLICATION NUMBER/
PATENT NUMBER** : 10202003065Y

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DATE OF GRANT : 27 January 2022

DATED THIS 27th DAY OF JANUARY 2022



Mrs. Rena Lee
Registrar of Patents
Singapore